Small Signal MOSFET

20 V, 200 mA, Dual N-Channel, 1.0 mm x 1.0 mm SOT-963 Package

Features

- Dual N-Channel MOSFET
- Offers a Low $R_{DS(ON)}$ Solution in the Ultra Small 1.0 x 1.0 mm Package
- 1.5 V Gate Voltage Rating
- Ultra Thin Profile (< 0.5 mm) Allows It to Fit Easily into Extremely Thin Environments such as Portable Electronics
- These are Pb-Free Devices

Applications

- General Purpose Interfacing Switch
- Optimized for Power Management in Ultra Portable Equipment

MAXIMUM RATINGS (T_J = 25°C unless otherwise specified)

| Para | Symbol | Value | Unit | | | |
|---|--------------------------------------|-----------------------|------------------|-----|----|--|
| Drain-to-Source Voltage | | | V _{DSS} | 20 | V | |
| Gate-to-Source Voltage | | | V _{GS} | ±8 | V | |
| Continuous Drain | Steady | $T_A = 25^{\circ}C$ | | 160 | mA | |
| Current (Note 1) | State | T _A = 85°C | I_{D} | 115 | | |
| | t ≤ 5 s | $T_A = 25^{\circ}C$ | | 200 | | |
| Power Dissipation | Steady State | T _A = 25°C | P _D | 125 | | |
| (Note 1) | | | | | mW | |
| | t ≤ 5 s | | | 200 | | |
| Pulsed Drain Current | I _{DM} | 800 | mA | | | |
| Operating Junction and | T _J , T _{STG} | -55 to 150 | °C | | | |
| Source Current (Body Diode) (Note 2) | | | I _S | 200 | mA | |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | | TL | 260 | °C | |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

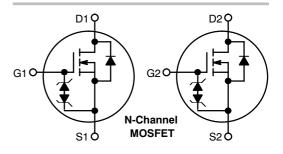
- Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz Cu.
- 2. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%

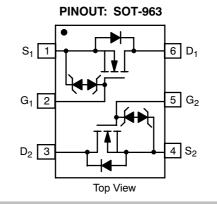


ON Semiconductor®

http://onsemi.com

| V _{(BR)DSS} | R _{DS(ON)} MAX | I _D Max |
|----------------------|-------------------------|--------------------|
| | 3.0 Ω @ 4.5 V | |
| 20 V | 4.0 Ω @ 2.5 V | 0.2 A |
| | 6.0 Ω @ 1.8 V | |
| | 10 Ω @ 1.5 V | |









N = Specific Device Code

M = Date Code

= Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

THERMAL RESISTANCE RATINGS

| Parameter | Symbol | Max | Unit |
|---|---------------|------|-------|
| Junction-to-Ambient - Steady State (Note 3) | D | 1000 | °C/W |
| Junction-to-Ambient – t = 5 s (Note 3) | $R_{	hetaJA}$ | 600 | O, VV |

^{3.} Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz Cu.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

| Parameter | Symbol | Test Condition | Min | Тур | Max | Unit | |
|--|----------------------|---|-----------------------|-----|------|------|-------|
| OFF CHARACTERISTICS | | • | | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 20 | | | V |
| Zero Gate Voltage Drain Current | | V _{GS} = 0 V, V _{DS} = 5 V | T _J = 25°C | | | 50 | nA |
| | I _{DSS} | | T _J = 85°C | | | 200 | |
| | | V _{GS} = 0 V, V _{DS} = 16 V | T _J = 25°C | | | 100 | |
| Gate-to-Source Leakage Current | I _{GSS} | V _{DS} = 0 V, V _{GS} = ±5.0 V | | | | 100 | nA |
| ON CHARACTERISTICS (Note 4) | • | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | $V_{GS} = V_{DS}, I_{D} = 250 \mu A$ | | 0.4 | | 1.0 | V |
| Drain-to-Source On Resistance | | V _{GS} = 4.5 V, I _D = 100 mA | | | 1.5 | 3.0 | |
| | | V _{GS} = 2.5 V, I _D = 50 mA | | | 2.0 | 4.0 | Ω |
| | R _{DS(ON)} | V _{GS} = 1.8 V, I _D = 20 mA | | | 3.0 | 6.0 | |
| | | V _{GS} = 1.5 V, I _D = 10 mA | | | 4.0 | 10 | |
| | | V _{GS} = 1.2 V, I _D = 1.0 mA | | | 5.5 | | |
| Forward Transconductance | 9FS | V _{DS} = 5.0 V, I _D = 125 mA | | | 0.35 | | S |
| Source-Drain Diode Voltage | V_{SD} | V _{GS} = 0 V, I _D = 10 mA | | | 0.6 | 1.0 | ٧ |
| CHARGES, CAPACITANCES AND GATE | RESISTANCE | | | | | | |
| Input Capacitance | C _{ISS} | | | | 9.0 | | |
| Output Capacitance | C _{OSS} | f = 1.0 MHz, V _{GS} = 0 V V _{DS} = 15 V | | | 3.0 | | pF |
| Reverse Transfer Capacitance | C _{RSS} | | | | 2.2 | | |
| SWITCHING CHARACTERISTICS, V _{GS} = | 4.5 V (Note 4) | | | | | | |
| Turn-On Delay Time | t _{d(ON)} | V_{GS} = 4.5 V, V_{DD} = 10 V, I_{D} = 200 mA, R_{G} = 2.0 Ω | | | 15 | | ns ns |
| Rise Time | t _r | | | | 24 | | |
| Turn-Off Delay Time | t _{d(OFF)} | | | | 90 | | |
| Fall Time | t _f | | | | 60 | | |

^{4.} Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES

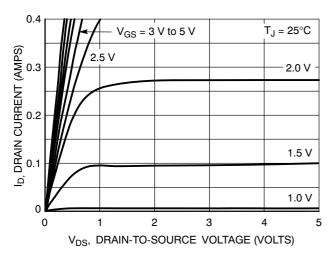


Figure 1. On-Region Characteristics

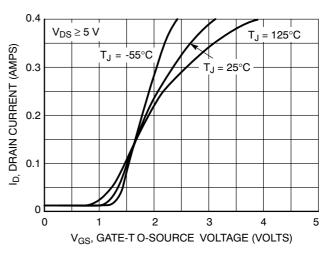


Figure 2. Transfer Characteristics

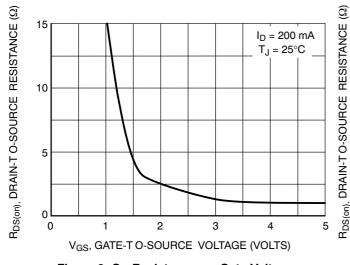


Figure 3. On-Resistance vs. Gate Voltage

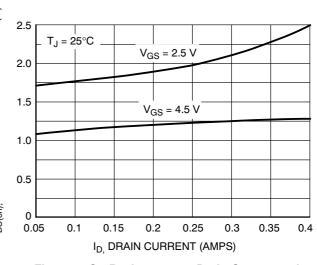


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

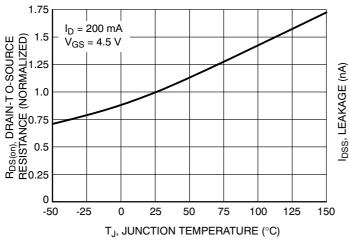


Figure 5. On-Resistance Variation with Temperature

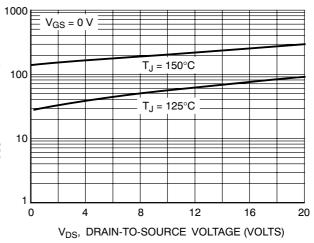


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL PERFORMANCE CURVES

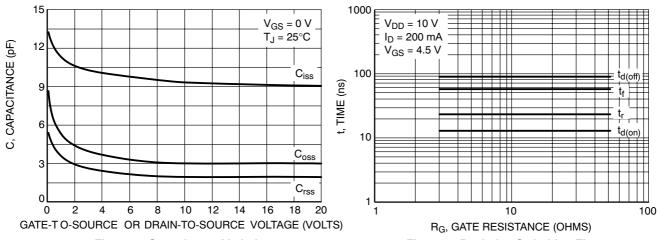


Figure 7. Capacitance Variation

Figure 8. Resistive Switching Time Variation vs. Gate Resistance

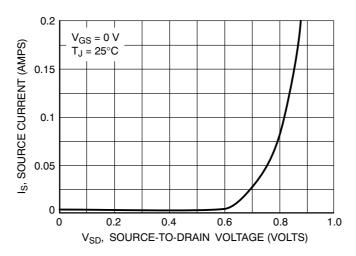


Figure 9. Diode Forward Voltage vs. Current

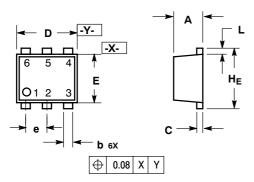
ORDERING INFORMATION

| Device | Package | Shipping [†] |
|--------------|----------------------|-----------------------|
| NTUD3128NT5G | SOT-963 (Pb-Free) | 8000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

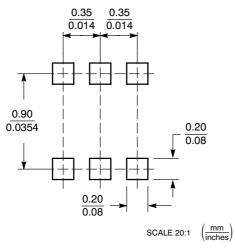
SOT-963 CASE 527AA-01 ISSUE A



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|----------|-------|
| DIM | MIN | NOM | MAX | MIN | MON | MAX |
| Α | 0.40 | 0.45 | 0.50 | 0.016 | 0.018 | 0.020 |
| b | 0.10 | 0.15 | 0.20 | 0.004 | 0.006 | 0.008 |
| С | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 |
| D | 0.95 | 1.00 | 1.05 | 0.037 | 0.039 | 0.041 |
| Е | 0.75 | 0.80 | 0.85 | 0.03 | 0.032 | 0.034 |
| е | 0.35 BSC | | | (| 0.014 BS | C |
| L | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 |
| HE | 0.95 | 1.00 | 1.05 | 0.037 | 0.039 | 0.041 |

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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